

# FDD1600N10ALZ N-Channel PowerTrench<sup>®</sup> MOSFET 100 V, 6.8 A, 160 mΩ

### Features

- $R_{DS(on)}$  = 124 m $\Omega$  (Typ.) @ V<sub>GS</sub> = 10 V, I<sub>D</sub> = 3.4 A
- R<sub>DS(on)</sub> = 175 mΩ (Typ.) @ V<sub>GS</sub> = 5 V, I<sub>D</sub> = 2.1 A
- Low Gate Charge (Typ.2.78 nC)
- Low C<sub>rss</sub> (Typ. 2.04 pF)
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability
- RoHS Compliant

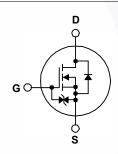
## Description

This N-Channel MOSFET is produced using Fairchld Semiconductor's advanced PowerTrench<sup>®</sup> process that has been tailored to minimize the on-state resistance and maintain superior switching performance.

### Application

- Consumer Appliances
- · LED TV and Monitor
- Synchronous Rectification
- Uninterruptible Power Supply
- Micro Solar Inverter





### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

| Symbol                            | Parameter  |   |   | FDD1600N10ALZ | Unit |  |
|-----------------------------------|--|---|---|---------------|------|--|
| V <sub>DSS</sub>                  | Drain to Source Voltage  |   |   | 100           | V    |  |
| V <sub>GSS</sub>                  | Gate to Source Voltage   |   |   | ±20           | V    |  |
| ID                                | Drain Current  | - Continuous (T <sub>C</sub> = 25 <sup>o</sup> C) | - Continuous (T <sub>C</sub> = 25 <sup>o</sup> C) |               | _    |  |
|                                   | Drain Current  | - Continuous (T <sub>C</sub> = 100 <sup>o</sup> C | )   | 4.3           | A    |  |
| I <sub>DM</sub>                   | Drain Current  | - Pulsed  | (Note 1)  | 13.6          | Α    |  |
| E <sub>AS</sub>                   | Single Pulsed Avalanche Energy (Note 2)                              |   | 5.08  | mJ            |      |  |
| dv/dt                             | Peak Diode Recovery dv/dt (Note 3)                                   |   | 6.0   | V/ns          |      |  |
| P <sub>D</sub>                    | Dower Dissinction  | (T <sub>C</sub> = 25°C)                           | $(T_{\rm C} = 25^{\rm o}{\rm C})$                 |               | W    |  |
|                                   | Power Dissipation  | - Derate Above 25°C                               |   | 0.12          | W/ºC |  |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature Range                              |   | -55 to +150                                       | °C            |      |  |
| TL                                | Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds |   |   | 300           | °C   |  |

### **Thermal Characteristics**

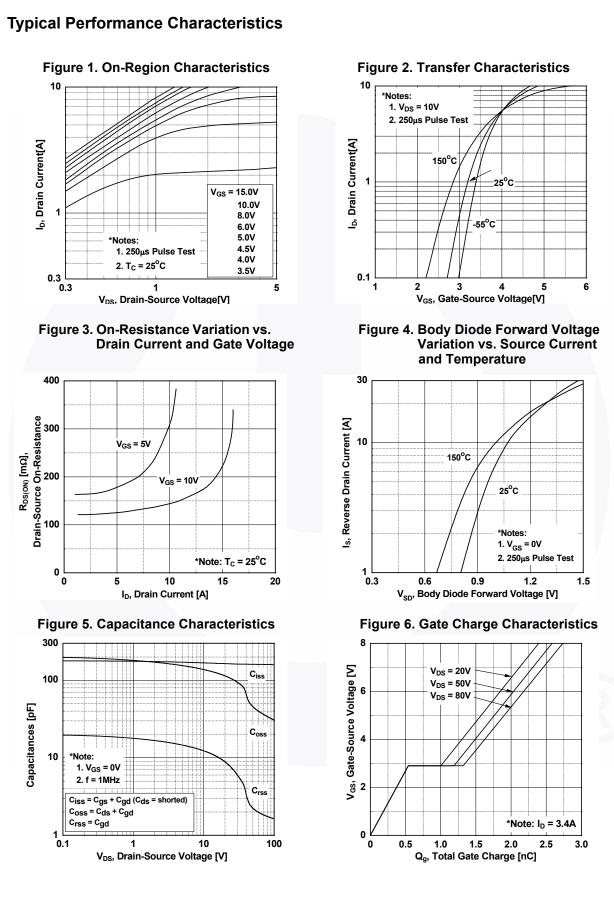
| Symbol              | Parameter                                     | FDD1600N10ALZ | Unit |
|---------------------|---|---------------|------|
| $R_{	ext{	heta}JC}$ | Thermal Resistance, Junction to Case, Max.    | 8.4           | °C/W |
| $R_{\thetaJA}$      | Thermal Resistance, Junction to Ambient, Max. | 87            | 0/00 |

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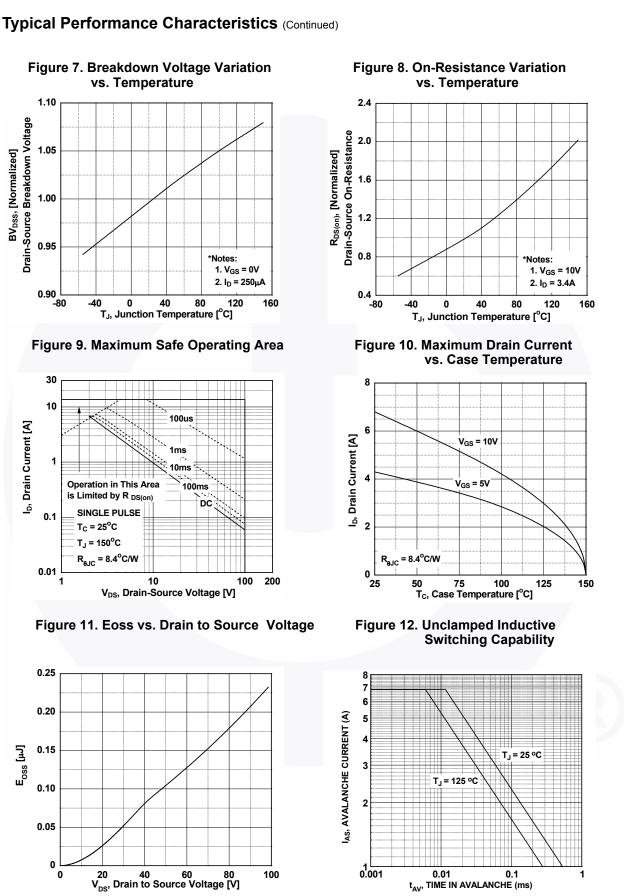
| •   |   | Top Mark  | Package         | Package Packing Method  |                        | Reel Size | Тар  | e Width    | Qua      | ntity    |
|---|---|---|-----------------|---|------------------------|-----------|------|------------|----------|----------|
|   |   | DPAK  | Tape and F      | Reel  | 330 mm                 | 1         | 6 mm | 2500 units |          |          |
| Electrica   | l Chara   | icteristics T <sub>c</sub> = 2  | 25ºC unless otl | nerwise noted.  |                        |           |      |            |          |          |
| Symbol  |   | Parameter   |                 |   | onditions              |           | Min. | Тур.       | Max.     | Unit     |
| Off Charac  | teristics   |   |                 |   |                        |           |      |            |          |          |
| BV <sub>DSS</sub>                                   |   | Source Breakdown Vo   | Itage I.        | <sub>0</sub> = 250 μA, V <sub>GS</sub>  | a = 0 V                |           | 100  | -          | -        | V        |
| $\Delta BV_{DSS}$                                   |   | wn Voltage Temperatur   | ro              |   |                        |           |      |            |          |          |
| / ΔT <sub>J</sub>                                   | Coefficient   |   | 1[              | $I_D$ = 250 µA, Referenced to 25°C  |                        |           | -    | 0.1        | -        | V/ºC     |
| I <sub>DSS</sub>                                    | Zero Gate Voltage Drain Current                             |   |                 | V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V   |                        |           | -    | -          | 1        | μA       |
| .033  |   | -   | V               | / <sub>DS</sub> = 80 V, V <sub>GS</sub>   |                        | = 125°C   | -    | -          | 500      |          |
| I <sub>GSS</sub>                                    | Gate to S   | Source Leakage Curre  | nt V            | ′ <sub>GS</sub> = ±20 V, V <sub>D</sub>   | <sub>os</sub> = 0 V    |           | -    | -          | ±10      | μA       |
| On Charac   | teristics   |   |                 |   |                        |           |      |            |          |          |
| V <sub>GS(th)</sub>                                 | Gate Thr  | eshold Voltage  | \<br>\          | / <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> =  | 250 uA                 |           | 1.4  | -          | 2.8      | V        |
|   |   |   | N               | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3.4 \text{ A}$  |                        |           | -    | 124        | 160      |          |
| R <sub>DS(on)</sub>                                 | Static Drain to Source On Resistance                        |   | stance –        | $V_{GS} = 5 V, I_D = 2.1 A$   |                        |           | -    | 175        | 375      | mΩ       |
| 9 <sub>FS</sub>                                     | Forward   | Transconductance  |                 | $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 6.8 \text{ A}$  |                        |           | -    | 19.6       | -        | S        |
| Dynamic C   | haracto   | ristics   |                 |   |                        |           |      |            |          |          |
| -   |   |   |                 |   |                        |           |      | 169        | 225      | pE       |
| C <sub>iss</sub>                                    |   | pacitance   | \               | / <sub>DS</sub> = 50 V, V <sub>GS</sub>   | <sub>s</sub> = 0 V,    |           | -    | 43         | 55       | pF<br>pF |
| C <sub>oss</sub>                                    | Output Capacitance Reverse Transfer Capacitance             |   | f               | f = 1 MHz   |                        | -         | 2.04 | 55         | pr<br>pF |          |
| C <sub>rss</sub>                                    |   | Related Output Capacit  | 2000            | / <sub>DS</sub> = 50 V, V <sub>GS</sub>   | - 0.1/                 |           | -    | 85         | -        | pF       |
| C <sub>oss(er)</sub>                                |   | e Charge at 10V   |                 | / <sub>DS</sub> = 30 V, V <sub>GS</sub><br>/ <sub>GS</sub> = 10 V   |                        |           |      | 2.78       | 3.61     | nC       |
| Q <sub>g(tot)</sub><br>Q <sub>g(tot)</sub>          |   | e Charge at 5V  |                 | $V_{\rm GS} = 10.V$   | V <sub>DD</sub> = {    | 50 V,     | -    | 1.5        | 1.95     | nC       |
| Q <sub>gs</sub>                                     |   | Source Gate Charge  |                 | GS OV   | I <sub>D</sub> = 6.8 A |           | -    | 0.72       | -        | nC       |
| Q <sub>gd</sub>                                     | Gate to Drain "Miller" Charge                               |   |                 |   |                        |           | -    | 0.56       | -        | nC       |
| ∽gu<br>V <sub>plateau</sub>                         |   | teau Volatge  |                 | (Note 4)  |                        | -         | 4.02 | -          | V        |          |
| Q <sub>sync</sub>                                   |   | e Charge Sync.  | \<br>\          |   |                        |           | 2.5  | -          | nC       |          |
| Q <sub>oss</sub>                                    | Output Charge<br>Equivalent Series Resistance (G-S)         |   |                 | $V_{DS} = 50 V, V_{GS} = 0 V$<br>f = 1 MHz  |                        |           | /    | 5.2        | -        | nC       |
| ESR   |   |   |                 |   |                        |           | -    | 2.1        | -        | Ω        |
| 0   | 0   |   |                 |   |                        |           |      |            |          |          |
| Switching   |   |   |                 |   |                        |           |      | i          |          | +        |
| t <sub>d(on)</sub>                                  | Turn-On Delay Time  |   |                 |   |                        |           | -    | 7          | 24       | ns       |
| t <sub>r</sub>                                      |   | Rise Time   |                 | $V_{DD}$ = 50 V, I <sub>D</sub> = 6.8 A,<br>V <sub>GS</sub> = 10 V, R <sub>G</sub> = 4.7 Ω                      |                        | -         | 2    | 14         | ns       |          |
| t <sub>d(off)</sub>                                 | Turn-Off Delay Time Turn-Off Fall Time                      |   |                 | (Note 4)  |                        |           | -    | 13         | 36       | ns       |
| t <sub>f</sub>                                      |   |   |                 |   |                        |           | -    | 2          | 14       | ns       |
| Drain-Sou   | rce Diod  | e Characteristics   | ;               |   |                        |           |      |            |          |          |
| I <sub>S</sub>                                      | Maximum   | Continuous Drain to   | Source Diode F  | orward Current  | t                      |           | -    | -          | 6.8      | А        |
| I <sub>SM</sub>                                     | Maximum Pulsed Drain to Source Diode F                      |   | ce Diode Forwa  | orward Current  |                        | -         | -    | 13.6       | Α        |          |
| V <sub>SD</sub>                                     | Drain to S  | Source Diode Forward  | Voltage V       | ′ <sub>GS</sub> = 0 V, I <sub>SD</sub> =  | 6.8 A                  |           | -    | -          | 1.3      | V        |
| t <sub>rr</sub>                                     | Reverse   | Recovery Time   | V               | $V_{GS} = 0 \text{ V}, I_{SD} = 6.8 \text{ A}, V_{DS} = 50 \text{ V},$<br>$dI_F/dt = 100 \text{ A}/\mu\text{s}$ |                        | -         | 37   | -          | ns       |          |
| Q <sub>rr</sub>                                     | Reverse   | Recovery Charge   | d               |   |                        | -         | 42   | -          | nC       |          |
| 2. L = 1 mH, $I_{AS}$ = 3. $I_{SD} \le 6.8$ A, di/d | 3.18 A,  R <sub>G</sub> = 2<br>t ≤ 200 A/μs, V <sub>I</sub> | mited by maximum junction te<br>5 $\Omega$ , starting T <sub>J</sub> = 25°C.<br><sub>DD</sub> $\leq$ BV <sub>DSS</sub> , starting T <sub>J</sub> = 25°C<br>rating temperature typical cha | с.              |   |                        |           |      |            |          |          |

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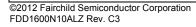
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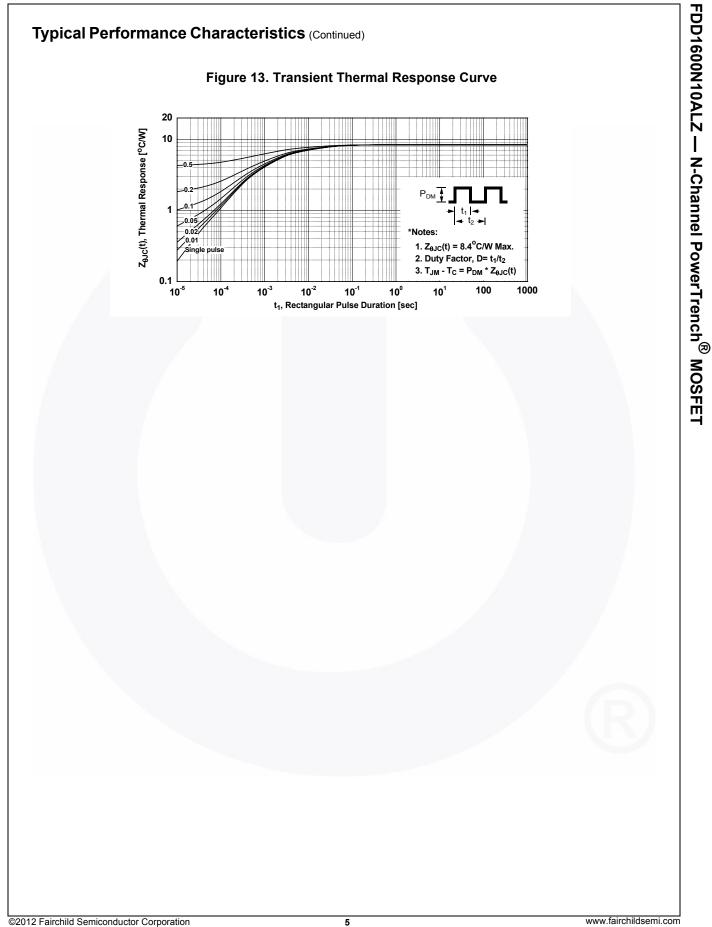


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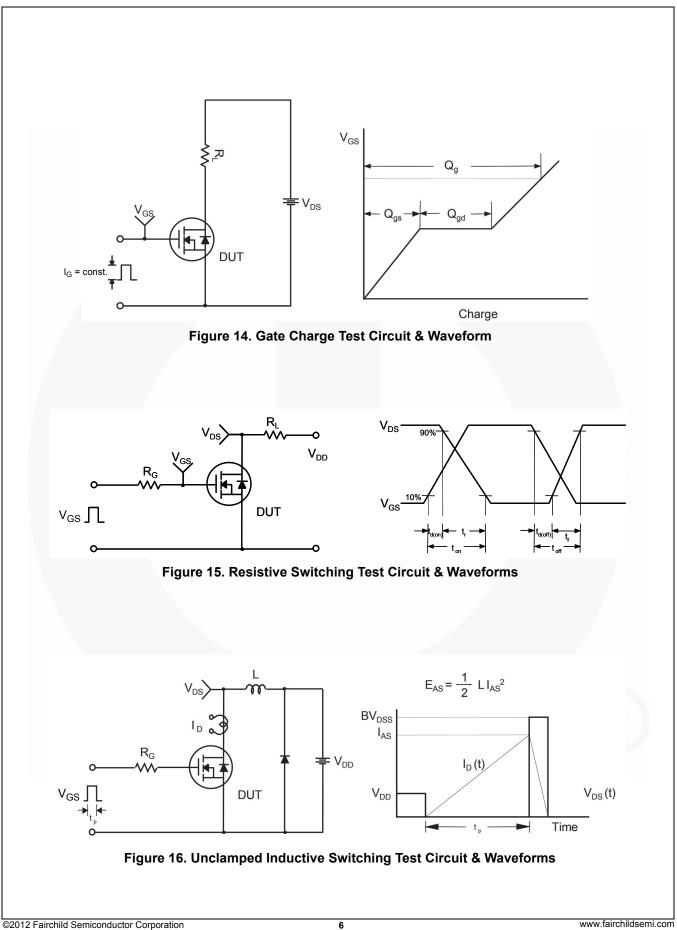
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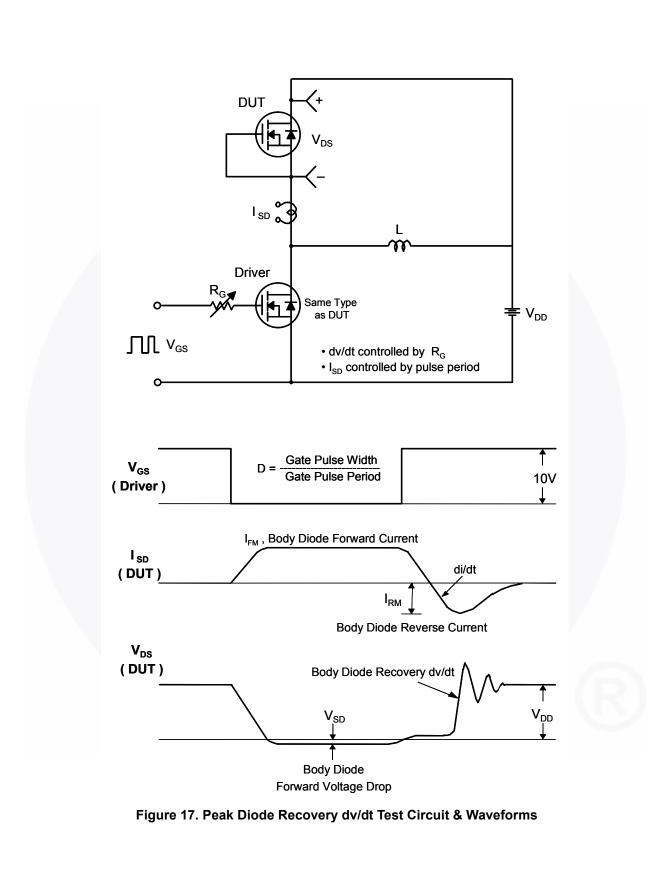
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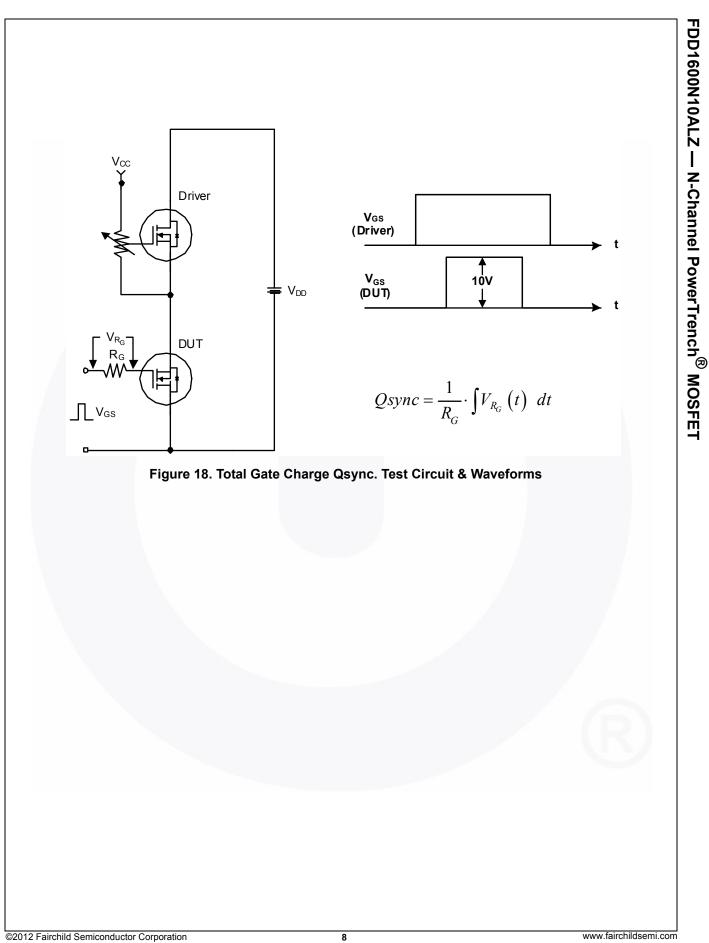


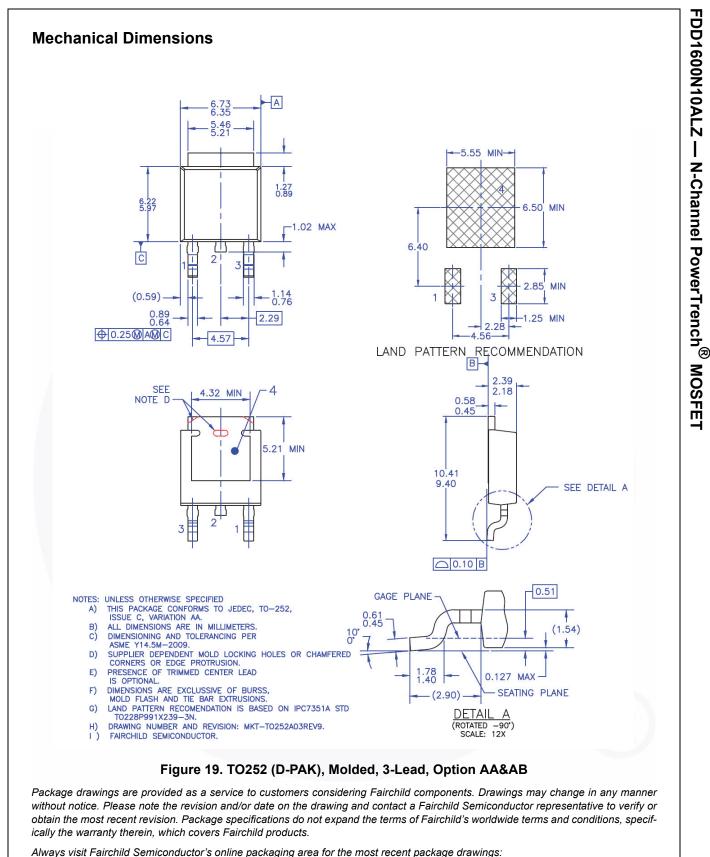
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